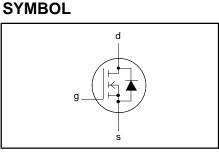
### **BSS123**

### FEATURES

- 'Trench' technology
- Extremely fast switching
- Logic level compatible
- Subminiature surface mounting package



### QUICK REFERENCE DATA

$$V_{\text{DSS}} = 100 \text{ V}$$
 
$$I_{\text{D}} = 150 \text{ mA}$$
 
$$R_{\text{DS(ON)}} \leq 6 \ \Omega \ (\text{V}_{\text{GS}} = 10 \text{ V})$$

3

Top view

2

SOT23

### GENERAL DESCRIPTION

N-channel enhancement mode field-effect transistor in a plastic envelope using '**trench**' technology.

#### **Applications:-**

- Relay driver
- High-speed line driver
- Telephone ringer

The BSS123 is supplied in the SOT23 subminiature surface mounting package.

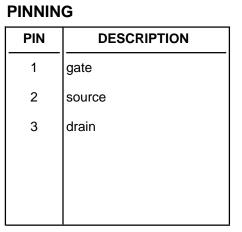
#### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>DSS</sub>	Drain-source voltage	$T_{j} = 25 \text{ °C to } 150 \text{ °C}$	-	100	V
V <sub>DGR</sub> V <sub>GS</sub>	Drain-gate voltage Gate-source voltage	$T_{j} = 25 \ ^{\circ}C \text{ to } 150 \ ^{\circ}C; R_{GS} = 20 \ k\Omega$	-	100 ± 20	V V
I <sub>D</sub>	Continuous drain current	T <sub>a</sub> = 25 °C	-	150	mA
I <sub>DM</sub>	Pulsed drain current	$T_a = 25 \degree C$	-	600	mA
	Total power dissipation	$T_a = 25 \degree C$	- - 55	0.25	W °C
T <sub>j</sub> , T <sub>stg</sub>	Operating junction and storage temperature		- 55	150	C

#### THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
unju	Thermal resistance junction to ambient	surface mounted on FR4 board	500	-	K/W

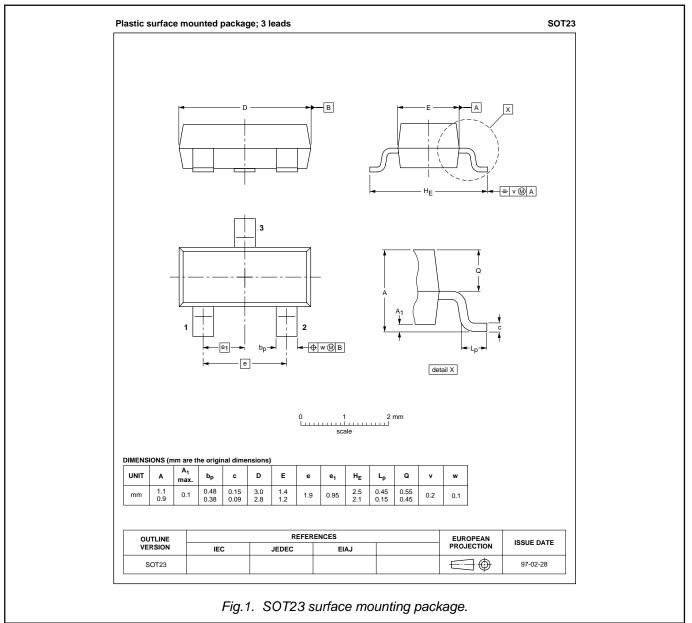


### **ELECTRICAL CHARACTERISTICS**

 $T_i = 25^{\circ}C$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; \text{ I}_{D} = 10 \mu\text{A}$	100	130	-	V
V <sub>GS(TO)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}; I_D = 1 \text{ mA}$	1	2	2.8	V
R <sub>DS(ON)</sub>	Drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 120 mA	-	3.5	6	Ω
<b>g</b> <sub>fs</sub>	Forward transconductance	$V_{DS} = 25 \text{ V}; \text{ I}_{D} = 120 \text{ mA}$	-	350	-	mS
I <sub>DSS</sub>	Zero gate voltage drain current	$V_{DS} = 60 \text{ V}; V_{GS} = 0 \text{ V}$	-	10	100	nA
I <sub>GSS</sub>	Gate source leakage current	$V_{GS} = \pm 20 \text{ V}; V_{DS} = 0 \text{ V}$	-	10	100	nA
t <sub>on</sub>	Turn-on time	$V_{DD}$ = 50 V; R <sub>D</sub> = 250 Ω; V <sub>GS</sub> = 10 V; R <sub>G</sub> = 50 Ω; Resistive load	-	3	10	ns
t <sub>off</sub>	Turn-off time		-	12	20	ns
C <sub>iss</sub>	Input capacitance	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 25 V; f = 1 MHz	-	23	40	рF
Coss	Output capacitance		-	6	25	pF
C <sub>rss</sub>	Feedback capacitance		-	4	10	pF

### **MECHANICAL DATA**



Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".

BSS123

### DEFINITIONS

Data sheet status			
Objective specification	tive specification This data sheet contains target or goal specifications for product development.		
Preliminary specification	specification This data sheet contains preliminary data; supplementary data may be published later		
Product specification	This data sheet contains final product specifications.		
Limiting values			
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.			
Application information			
Where application information is given, it is advisory and does not form part of the specification.			
© Philips Electronics N.V. 2000			
All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.			

The information presented in this document does not form part of any quotation or contract, it is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent or other industrial or intellectual property rights.

#### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by NXP manufacturer:

Other Similar products are found below :

614233C 648584F MCH3443-TL-E MCH6422-TL-E FDPF9N50NZ FW216A-TL-2W FW231A-TL-E APT5010JVR NTNS3A92PZT5G IRF100S201 JANTX2N5237 2SK2464-TL-E 2SK3818-DL-E FCA20N60\_F109 FDZ595PZ STD6600NT4G FSS804-TL-E 2SJ277-DL-E 2SK1691-DL-E 2SK2545(Q,T) 405094E 423220D MCH6646-TL-E TPCC8103,L1Q(CM 367-8430-0972-503 VN1206L 424134F 026935X 051075F SBVS138LT1G 614234A 715780A NTNS3166NZT5G 751625C 873612G IRF7380TRHR IPS70R2K0CEAKMA1 RJK60S3DPP-E0#T2 RJK60S5DPK-M0#T0 APT5010JVFR APT12031JFLL APT12040JVR DMN3404LQ-7 NTE6400 JANTX2N6796U JANTX2N6784U JANTXV2N5416U4 SQM110N05-06L-GE3 SIHF35N60E-GE3 2SK2614(TE16L1,Q)